

| Moisture sensitivity level: Level 1

## **FEATURES**

Size Design Ф8.0\*10.0mm

High Current Handling Capability 10,000A @ 8/20 µs

Low Capacitance and Insertion Loss

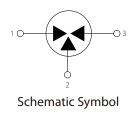
Quick Response and Long Service Life



## Ф8.0\*10.0mm

# **APPLICATION INFORMATION**

Communication equipment.
Repeaters, Modems
Telephone Interface,Line cards.
Data communication equipment.



# **AGENCY APPROVALS**

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
<b>®</b>	Mean lead free		
<i>1</i> <b>R</b> 。	UL Certificated E505857		

# **PRODUCT CHARACTERISTICS**

Lead Material	Body Material	Terminal Finish		
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated		



## **ELECTRICAL PARAMETER**

Parameter	Symbol	Rating	Unit
DC Blocking Voltage 1)	100V/s	376-564	V
Language Consult access Valles are	At 1kV/μs	for 99 % of measured values ≤1100	V
Impulse Spark-over Voltage	At 1kV/μs	Typical values of distribution ≤1000	V
Impulse Discharge Current 2)	8/20µs	10	KA
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz	V <sub>DC</sub> =0.5V	≤ 2	рF
Operating and Storage Temperature		-40~125	°C

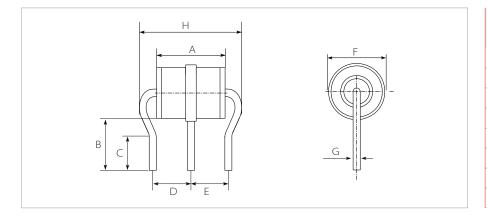
<sup>1)</sup> In ionized mode

# **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards		
High Temperature Storage Test	Temperature: 85°C ;Time:2H		
Low Temperature Storage Test	Temperature: -40°C ; Time:2H		
Vibration	Frequency: 10-500Hz; Amplitude: 0.15mm; Time:45min		
Resistance of soldering heat Temperature: 260°C; Time of dip soldering: 10s,1time			

**NOTE:** Up-screen program can be specified by customer's request via contacting Semiware service

# **PRODUCT DIMENSIONS**

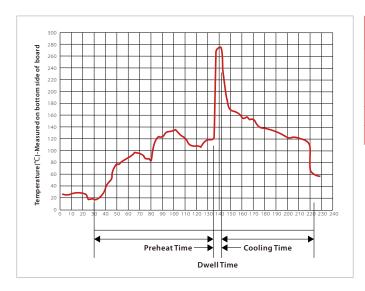


Ref.	Outline Dimensions		
Kei.	Millimeters		
Α	10±0.3		
В	7.0±0.5		
C	4.0±0.5		
D	4.4±0.3		
E	4.4±0.3		
F	Ф8.0±0.2		
G	Ф1.0		
Н	13±1		

<sup>2)</sup> Terms and waveforms in accordance with ITU-T Rec. K. 12; IIEC 61643-311



## **WAVE SOLDERING**



Wave Parameter		Lead-free assembly
Pre Heat	Temperature Min	100°C
	Temperature Max	150°C
	Time(min to max)	60 – 180 secs
Solder pot Temperature		280°C Max
Solder Dwell Time		2-5 seconds

# **ORDERING INFORMATION**

Doub November	C:	Administration on		Qty/pcs	
Part Number	Size	Marking	Tray	Inner Box	Carton
SG3R08B470	Ф8.0*10.0mm	<b>ℯ</b> SG470 <u>08</u>	100	500	6000



## Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

### Hotline

400-021-5756

### Web

Https://www.semiware.com

### Sales Center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

### **Customer Service**

Tel: 86-21-5484-1001 Email: sales17@semiware.com

## **Technical Support**

Tel: 86-21-3463-7654 Email: fae01@semiware.com

## **Complaint & Suggestions**

Tel: 86-21-3463-7172 Ext: 8868 Email: cs03@semiware.com

## By QR Code





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